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EOL of 25nm LPDDR4 8Gb-based (Z91M) 200b BGA packages

PCN: 31911

Published: 2016-04-18

Type:	End of Life
Description:	Micron's 25nm LPDDR4 8Gb-based (Z91M) 200b BGA packages are being replaced by 20nm process technology parts (Z01M)
Reason:	Manufacturing Efficiency
Product Affected:	25nm LPDDR4 8Gb-based (Z91M) 200b BGA packages

Affected Micron Part Number	Recommended Replacement	Customer Part Number
<u>Component</u>		
MT53B256M32D1GZ-062 AIT:B	MT53B256M32D1NP-062 AIT:C	
MT53B256M32D1GZ-062 WT:B	MT53B256M32D1NP-062 WT:C	
MT53B512M32D2GZ-062 AIT:B	MT53B512M32D2NP-062 AIT:C	
MT53B512M32D2GZ-062 WT:B	MT53B512M32D2NP-062 WT:C	

*Materials that have been ordered are in **bold**.

Method of Identification:	Marketing Part Number
Micron Sites Affected:	All Sites
Sample Available:	2016-05-20
Qual Data Available:	2016-06-20

Last Purchase Date*: 2016-07-15

Last Shipment Date: 2016-10-15

*Orders placed prior to the last purchase date are subject to current inventory levels, which may vary based on market conditions and customer demand. Early orders are encouraged.

NOTE: Per JEDEC Standard JESD46-C Section 3.2.3; lack of acknowledgment of this PCN within 30 days constitutes acceptance of change.

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